Motivation: EU Chips Act

The European Chips Act will boost Europe’s technological sovereignty, competitiveness, resilience and contribute to the digital and green transitions.

Why do we need a European Chips Act?

Chips — also known as semiconductors — are the building block of all electronic products. They play a central role in our modern economies and our daily lives. Chips underpin the digital transformation and are essential to all industries, such as the car industry, communications, data processing, space, defence, smart devices and gaming, to name a few.

The recent global chips shortage has disrupted supply chains, caused product shortages ranging from cars to medical devices, and in some cases even forced factories to close.

The European Chips Act, having reached a political agreement on 18 April 2023, seeks to strengthen the semiconductor ecosystem. It is composed of a Communication, which spells out the European Strategy and rationale behind the Chips Act, a proposal for a Regulation, and a Recommendation to Member States.

AERO
Accelerated EuRopean clOud

Vision

Enable the future heterogeneous EU cloud infrastructure

AERO will upbring and optimise software for the heterogeneous cloud ecosystem on the European processor:

- compilers, runtime systems
- operating systems, system software
- auxiliary software deployment services.

Accelerate the adoption of the EU cloud ecosystem

- Accelerate the adoption of the EU cloud ecosystem
- Open source ecosystem
- Communication and dissemination of results to industry, academia, and standardization bodies.
AERO
HW Platforms

• Numerous processor designs derived by the European Processor Initiative [1] and other projects
• AERO focuses on SIPEARL’s Rhea processor
  • ARM Neoverse V1 processors
  • PCIe support for GPUs
  • RISC-V accelerators
• RISC-V platforms
• FPGA boards for rapid prototyping
• GPUs and other accelerators
AERO

System Software | Execution Runtimes

Optimized execution of programming languages & runtime systems primed for cloud:

- **OpenJDK, GraalVM** → managed programming languages (Java, Python, Scala, R, etc.)
- **TornadoVM** → GPU HW acceleration of managed programming languages
- **Quarkus** → Cloud Microservices
- **SYCL & DPC++/OneAPI** → HW acceleration of non-managed applications running in C/C++
Java on the EU Processor

• Focus of The University of Manchester and Red Hat
• Optimize production JVMs on the heterogeneous EU platforms
  • AArch64, RISC-V, GPU/FPGA Acceleration
• OpenJDK, Mandrel, GraalVM, Quarkus and TornadoVM
• Aim for stability, compatibility and performance
TornadoVM

A JVM plugin that accelerates Java methods on heterogeneous hardware!

Features:
• Lightweight API
• Platform agnostic
• Automatic code specialization

https://tornadovm.org
@tornadovm
Funded by the European Union

TornadoVM

Java

Java Virtual Machine (e.g. OpenJDK)

+ 

TornadoVM

JVMs: OpenJDK, GraalVM, RH Mandrel, AWS Corretto, MS JDK

HW: GPUs (Intel, NVIDIA, AMD), FPGAs (Intel, Xilinx), CPUs (x86, Aarch64)
TornadoVM | Execution Model

```
TaskGraph taskGraph = new TaskGraph("tg")
    .transferToDevice(DataTransferMode.FIRST_EXECUTION, input)
    .task("methodA", Class::MethodA, input, output, ...)
    .transferToHost(DataTransferMode.EVERY_EXECUTION, output);
```

A) **Loop Parallel API** for Java programmers | Easy to use, lightweight

B) **Kernel API** for programmers with OpenCL/CUDA expertise, or not (e.g. porting existing kernels) | Advanced features and capabilities
TornadoVM | Use Cases

https://www.tornadovm.org/use-cases
Thank you!

Contact us:

- aero-project.eu
- @AERO_Project_EU
- github.com/AERO-Project-EU
- zenodo.org/communities/aero
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